



DeviceClip platform DC4S main features

- ✓ 4 independent ISP channels (targets)
- ✓ 6 data signals per channel
- ✓ Relay isolation barrier on all channels

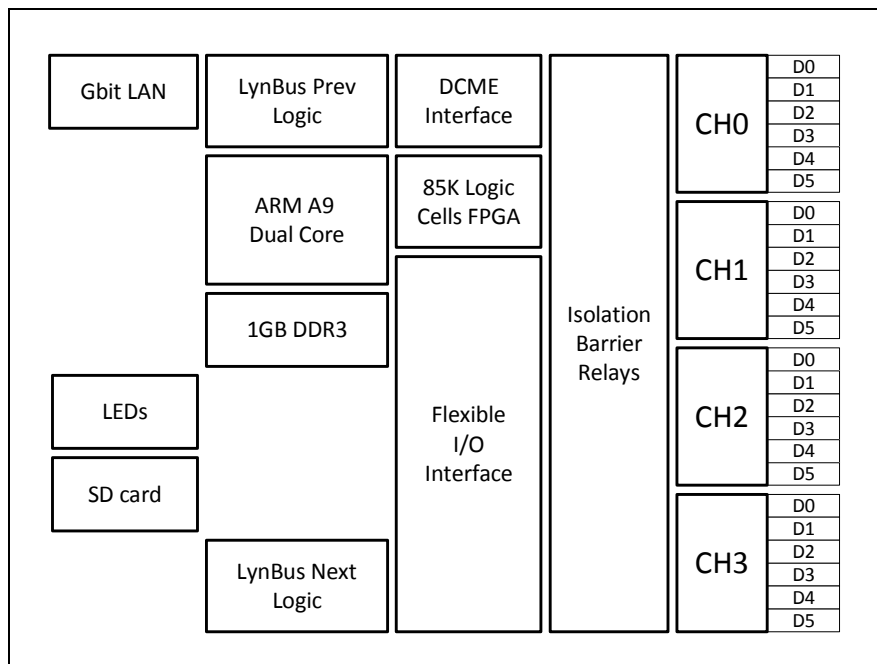
DeviceClip architecture overview

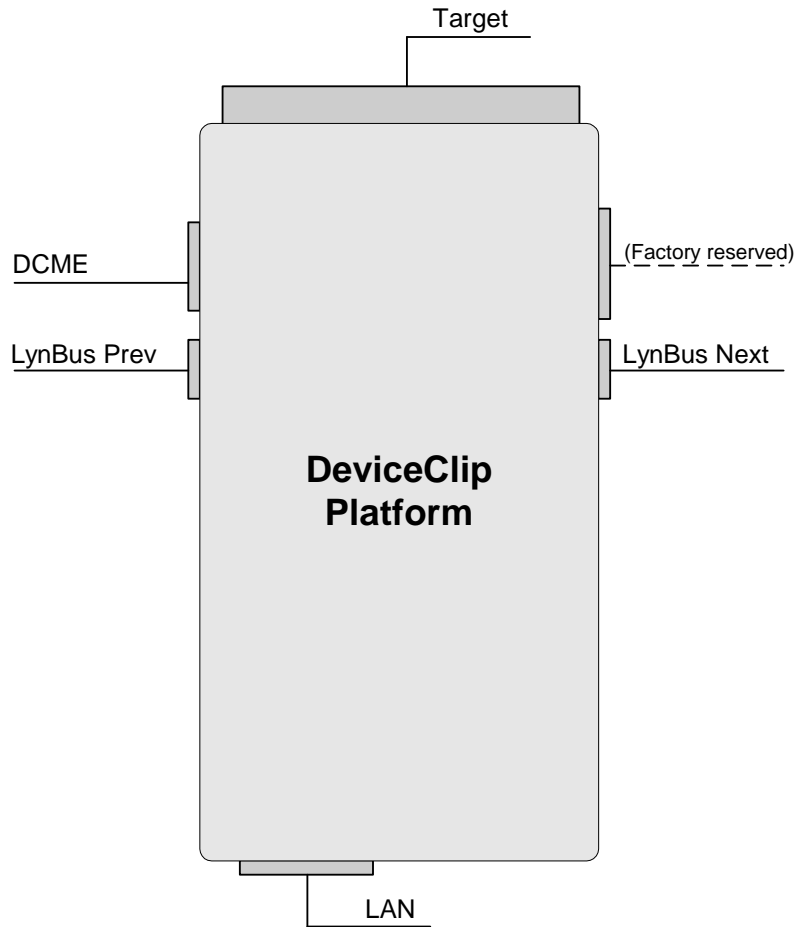
DeviceClip is a hi-performance, professional, universal, modular platform for the in-system programming of every type of semiconductor devices (microcontrollers, serial memories, PLDs from every semiconductor producer). It is provided of a number of true-parallel channels for the simultaneous support of totally different (heterogeneous) devices.

Unlike other programming tools, DeviceClip was conceived to work from inside the test fixture. Compact size allows placement at very short distance from the device to be programmed, dramatically reducing signal noise and allowing the target device maximum speed to be achieved.

Thanks to its ultra-high speed and unlimited number of truly parallel channels, DeviceClip offers the market most competitive cost of operation when supporting panels of PCBAs.

Block diagram





Target ISP data signals for target device(s) and DeviceClip power. Pin assignments are on the specific section below.

LynBus Next This connector allows cascading of more DeviceClip platforms to form a larger than one unit programming system. See DeviceClip Architecture User's Manual for details.

LAN This connector allows an RJ-45 host LAN to be linked through DCLA adapter provided on DeviceClip ToolBox.

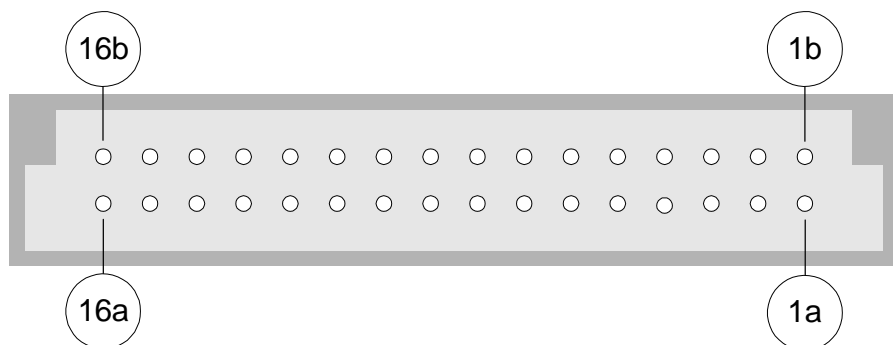
LynBus Prev This connector allows cascading of more DeviceClip platforms to form a larger than one unit programming system. See DeviceClip Architecture User's Manual for details.

DCME This connector allows the connection of a Lynxar Technologies DCME module. See DeviceClip Architecture User's Manual for details.

Target connector

DeviceClip Target connector is a standard DIN41612 32-pin header (rows a-b). It carries ISP data signals and also conveys power supply to the platform. The following figure shows the Target connector pin assignment.

Pin	Row a	Row b
1	CH0_D0	CH0_D1
2	CH0_D2	CH0_D3
3	CH0_D4	CH0_D5
4	GND	GND
5	CH1_D0	CH1_D1
6	CH1_D2	CH1_D3
7	CH1_D4	CH1_D5
8	CH2_D0	CH2_D1
9	CH2_D2	CH2_D3
10	CH2_D4	CH2_D5
11	GND	GND
12	CH3_D0	CH3_D1
13	CH3_D2	CH3_D3
14	CH3_D4	CH3_D5
15	GND	GND
16	POWER	POWER



On this table, four-channel target ISP signals are represented as CH_c_D_s, where 'c' is the channel number and 's' is the data signal for the related channel. When implementing DeviceClip on your application, make sure to connect POWER to a VCC voltage.

A mating wire-wrap connector is included on DeviceClip platform package and can be used to join the Target connector signals to the nails of your test fixture.

DeviceClip platform series can be installed in common, wire-wrap fixtures or in wireless fixtures. Suggested mating connector for the two options are:

	Wire-wrap fixture	Wireless fixture
Manufacturer	Conec	Hirose
Manufacturer P/N	122 A 10439 X	PCN10C-32S-2.54DS(72)
Digi-Key P/N	122A10439X-ND	H11170-ND

General characteristics

Item	Min	Typ	Max	Units
Processor operating frequency (Dual-core ARM® Cortex™-A9)		667		MHz
SDRAM (DDR3L) size		1		GB
SDRAM (DDR3L) performance		1.066		GB/s
Storage memory (Micro SDHC card)	4	8	32	GB
Supply voltage	6	12	16	V
Power consumption		3.6		W
Peak current (@12V)		1.7		A
Length		107		mm
Width		60		mm
Height		10		mm
Weight		70		g
Operational temperature		5-70		°C

Channel description

DeviceClip model DC4S is provided of 4 channels (CH0-CH3).

Each of DeviceClip model DC4S channels is provided of 6 data signals (D0-D5).

Data signals, depending on the target device being managed, are configured by Applications in one of the following modes:

Mode	Mode name	I/O type	Applicable
0	High impedance (Z)	Z	D0-D5
1	Digital input	IN	D0-D5
2	Digital input (3.3KΩ pull-up)	IN	D0-D5
3	Push-pull digital output	OUT	D0-D5
4	Open drain digital output	OUT	D0-D5
5	Open drain digital output (3.3KΩ pull-up)	OUT	D0-D5
6	Clock digital push-pull output	OUT	D0-D5
7	High voltage	VPP	D0

Note: Target data signals voltage ($V_{CC_{TIO}}$) is programmable and ranges from 1.56V to 5.04V.

Electrical characteristics (mode 0)

Maximum leakage current (@25°C): 2uA.

Electrical characteristics (modes 1-2)

$V_{CC_{TIO}}$	V_{IL}	V_{IH}	Unit
1.65 to 1.95	$V_{CC_{TIO}} * 0.35$	$V_{CC_{TIO}} * 0.65$	V
2.3 to 2.7	0.7	1.7	V
3.0 to 3.6	0.8	2.0	V
4.5 to 5.5	$V_{CC_{TIO}} * 0.30$	$V_{CC_{TIO}} * 0.70$	V

Electrical characteristics (modes 3-6)

$V_{CC_{TIO}}$	V_{OL}	V_{OH}	Unit
1.65	0.45 @4mA	1.20 @-4mA	V
2.3	0.30 @8mA	1.90 @-8mA	V
3	0.55 @24mA	2.40 @-24mA	V
4.5	0.55 @32mA	3.80 @-32mA	V

Electrical characteristics (mode 7)

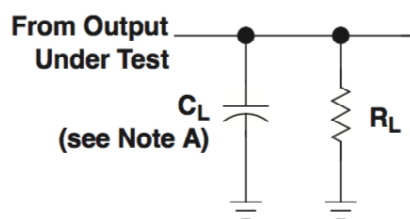
VPP voltage is programmable and ranges from 4.96V to 15.80V, +/-5 % (granularity: 42mV).

Absolute maximum ratings

Signal	Min	Max	Unit
POWER	-50	20	V
Data signals	-24	$V_{CC_{TIO}} + 24$	V

Switching characteristics

Test conditions ($R_L = 2k\Omega$, $C_L = 15pF$)



Note A: CL includes probe and jig capacitance.

$V_{CC_{TIO}}$	Rise Time (min)	Rise Time (max)	Fall Time (min)	Fall Time (max)	Unit
1.8	2.7	4.6	1.5	2.6	ns
2.5	1.8	1.9	1.5	1.7	ns
3.3	0.9	1.6	0.9	1.5	ns
5	1.5	2.5	1.0	1.8	ns

DeviceClip architecture available literature

- Architecture Overview Brochure
- Architecture User's Manual
- Platforms Data Sheets
- Apps (programming algorithms) Data Sheets

Document code: **DC02058**

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